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Applicant: Jack O. Chu

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Examiner: E.J. Wojciechowicz

For: A TRANSFERABLE DEVICE-CONTAINING LAYER
FOR SILICON-ON-INSULATOR APPLICATIONS

Commissioner for Patents
Washington, D.C. 20231

CERTIFICATE OF MAILING UNDER 37 CFR 1.8 (a)

I hereby certify that the attached correspondence comprising:

1. Acknowledgment Post Card;
2. Petition and Fee for Extension of Time
(37 CFR 1.136(a)) (in duplicate); and
3. Response to a Requirement for Restriction Under 37 CFR
1.142

is being deposited with the United States Postal Service as first class mail in an envelope addressed to:

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on May 23, 2002

Michelle Parra

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A handwritten signature in black ink that reads "Michelle Parra".

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Attorney Docket No. YOR920000692US1